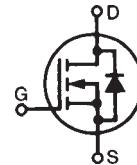
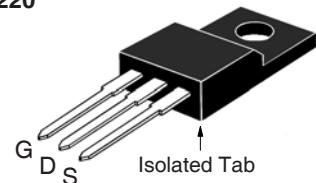


**X2-Class  
Power MOSFET™**
**IXTP20N65X2M**

**V<sub>DSS</sub>** = 650V  
**I<sub>D25</sub>** = 20A  
**R<sub>DS(on)</sub>** ≤ 185mΩ


**(Electrically Isolated Tab)**
**N-Channel Enhancement Mode**

Symbol	Test Conditions	Maximum Ratings	
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	650	V
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150°C, R <sub>GS</sub> = 1MΩ	650	V
V <sub>GSS</sub>	Continuous	±30	V
V <sub>GSM</sub>	Transient	±40	V
I <sub>D25</sub>	T <sub>C</sub> = 25°C, Limited by T <sub>JM</sub>	20	A
I <sub>DM</sub>	T <sub>C</sub> = 25°C, Pulse Width Limited by T <sub>JM</sub>	22	A
I <sub>A</sub>	T <sub>C</sub> = 25°C	5	A
E <sub>AS</sub>	T <sub>C</sub> = 25°C	400	mJ
dv/dt	I <sub>S</sub> ≤ I <sub>DM</sub> , V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C	15	V/ns
P <sub>D</sub>	T <sub>C</sub> = 25°C	36	W
T <sub>J</sub>		-55 ... +150	°C
T <sub>JM</sub>		150	°C
T <sub>stg</sub>		-55 ... +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C
V <sub>ISOL</sub>	50/60 Hz, 1 Minute	2500	V~
M <sub>d</sub>	Mounting Torque	1.13 / 10	Nm/lb.in
Weight		2.5	g

**OVERMOLDED  
TO-220**


G = Gate      D = Drain  
 S = Source

**Features**

- International Standard Package
- Plastic Overmolded Tab
- Low R<sub>DS(ON)</sub> and Q<sub>G</sub>
- Avalanche Rated
- 2500V~ Electrical Isolation
- Low Package Inductance

**Advantages**

- High Power Density
- Easy to Mount
- Space Savings

**Applications**

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	650		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.5		4.5 V
I <sub>GSS</sub>	V <sub>GS</sub> = ±30V, V <sub>DS</sub> = 0V			±100 nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V T <sub>J</sub> = 125°C			5 μA 50 μA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A, Note 1	155	185	mΩ

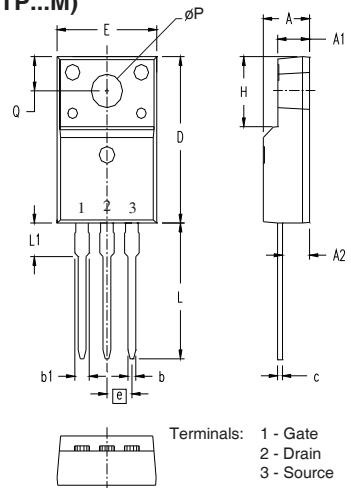
Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
<b>I<sub>fs</sub></b>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 10A, Note 1	11	18	S
R <sub>Gi</sub>	Gate Input Resistance		3.7	Ω
C <sub>iss</sub>		1450		pF
C <sub>oss</sub>		1060		pF
C <sub>rss</sub>		1.4		pF
<b>Effective Output Capacitance</b>				
C <sub>o(er)</sub>	Energy related } V <sub>GS</sub> = 0V	64		pF
C <sub>o(tr)</sub>	Time related } V <sub>DS</sub> = 0.8 • V <sub>DSS</sub>	250		pF
t <sub>d(on)</sub>		19		ns
t <sub>r</sub>		27		ns
t <sub>d(off)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 10A	47		ns
t <sub>f</sub>	R <sub>G</sub> = 10Ω (External)	20		ns
Q <sub>g(on)</sub>		27		nC
Q <sub>gs</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 10A	8		nC
Q <sub>gd</sub>		11		nC
R <sub>thJC</sub>			3.5 °C/W	
R <sub>thCS</sub>		0.50		°C/W

### Source-Drain Diode

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
I <sub>s</sub>	V <sub>GS</sub> = 0V		20	A
I <sub>SM</sub>	Repetitive, Pulse Width Limited by T <sub>JM</sub>		80	A
V <sub>SD</sub>	I <sub>F</sub> = I <sub>s</sub> , V <sub>GS</sub> = 0V, Note 1		1.4	V
t <sub>rr</sub>		350		ns
Q <sub>RM</sub>	I <sub>F</sub> = 10A, -di/dt = 100A/μs	4.3		μC
I <sub>RM</sub>	V <sub>R</sub> = 100V	24.6		A

Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

### OVERMOLDED TO-220 (IXTP...M)



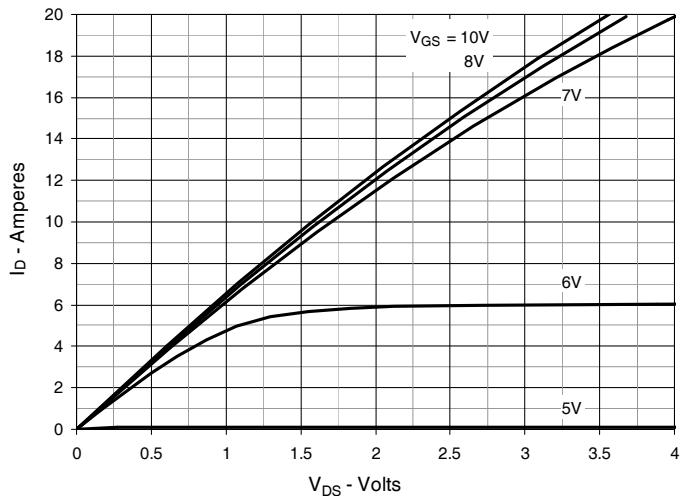
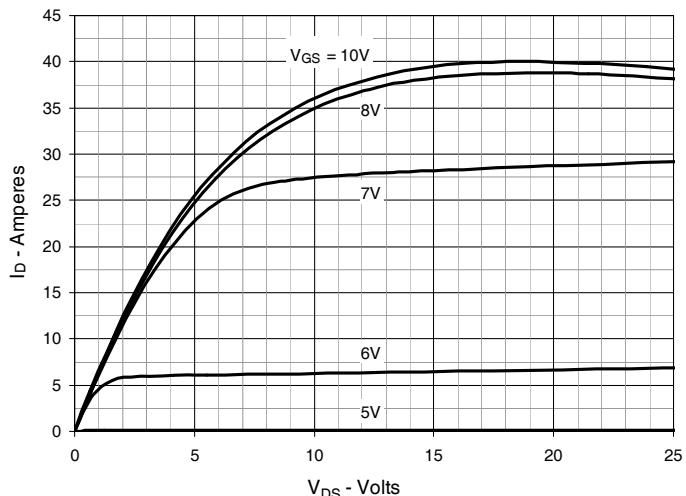
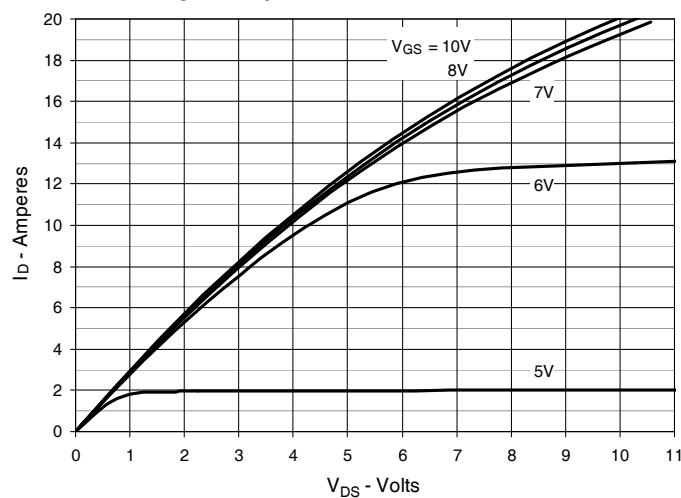
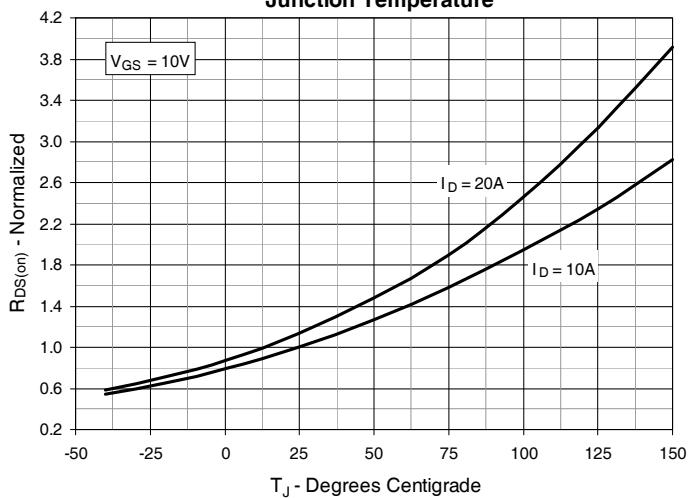
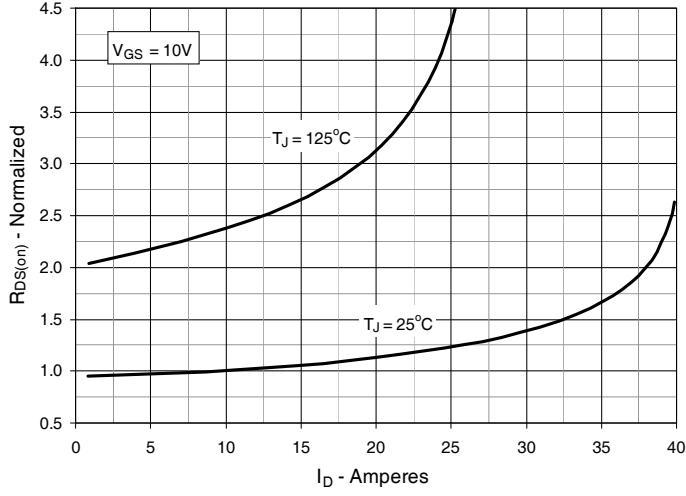
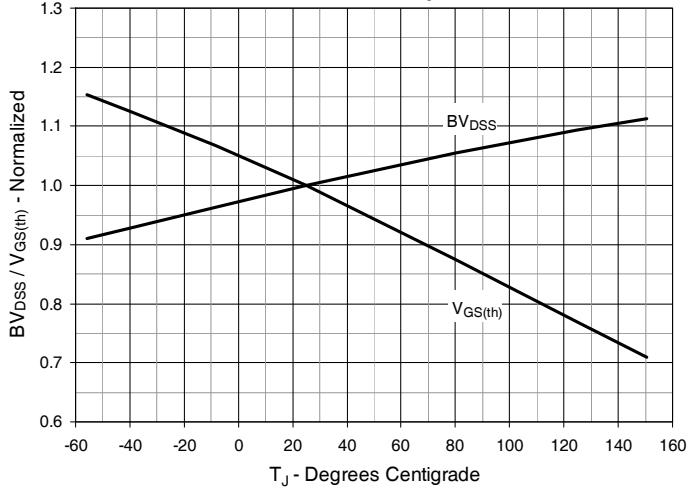
SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.177	.193	4.50	4.90
A1	.092	.108	2.34	2.74
A2	.101	.117	2.56	2.96
b	.028	.035	0.70	0.90
b1	.050	.058	1.27	1.47
c	.018	.024	0.45	0.60
D	.617	.633	15.67	16.07
E	.392	.408	9.96	10.36
e	.100	BSC	2.54	BSC
H	.255	.271	6.48	6.88
L	.499	.523	12.68	13.28
L1	.119	.135	3.03	3.43
ØP	.121	.129	3.08	3.28
Q	.126	.134	3.20	3.40

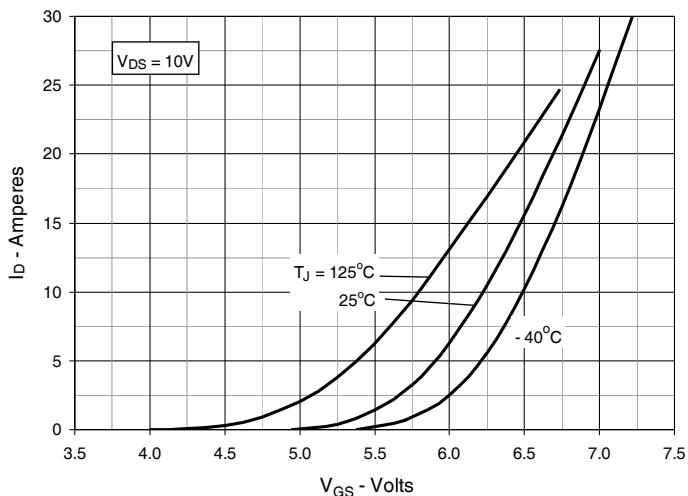
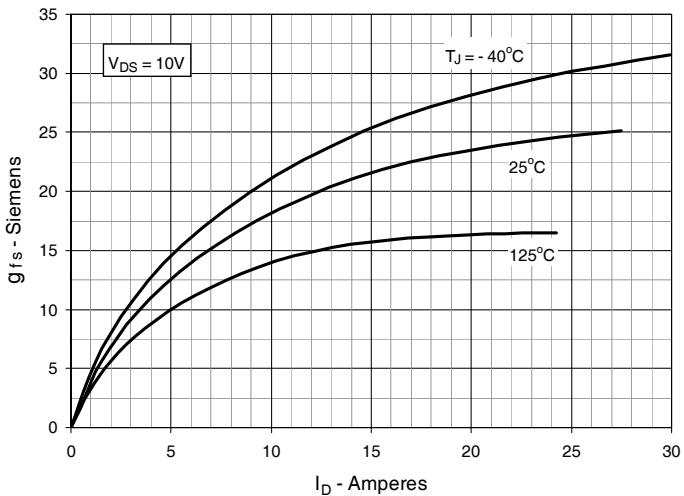
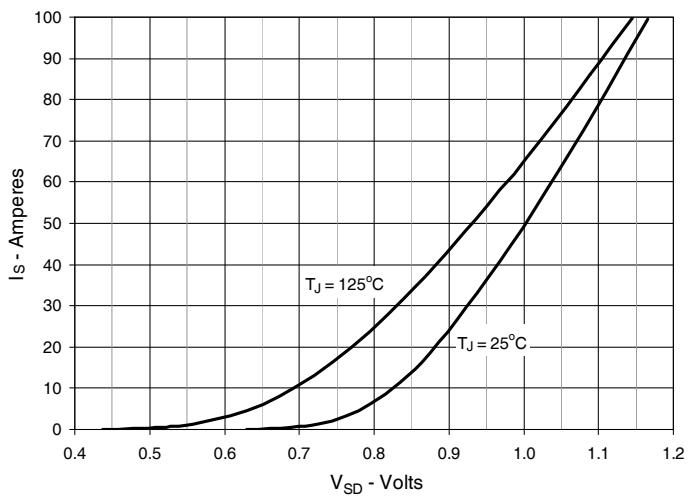
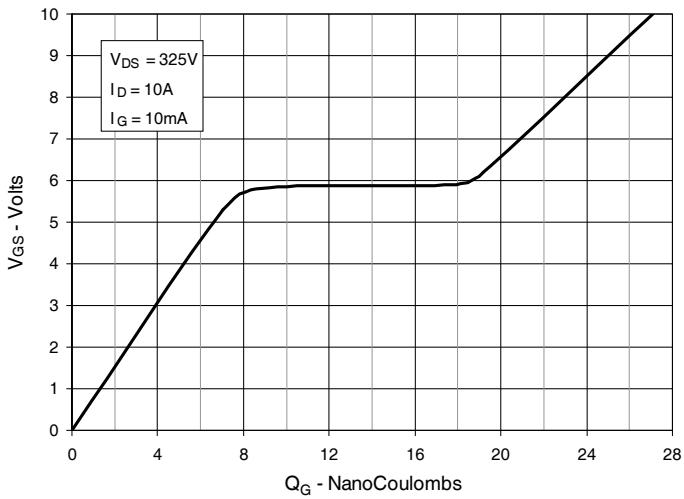
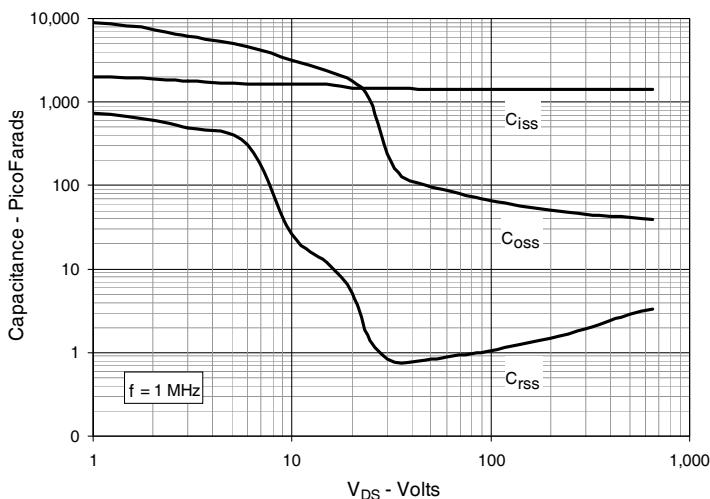
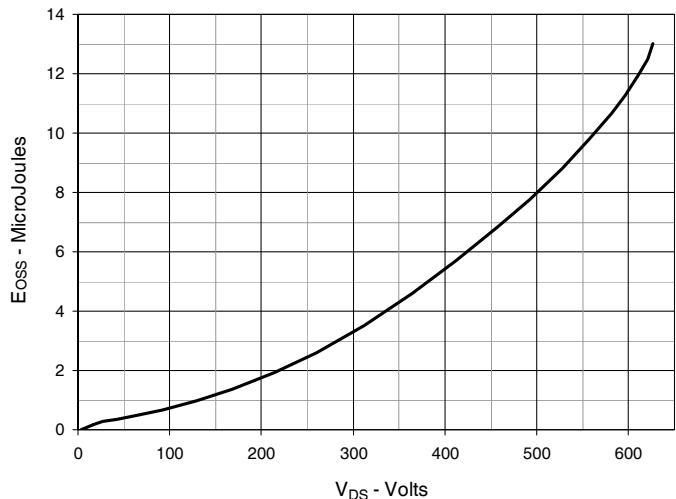
### PRELIMINARY TECHNICAL INFORMATION

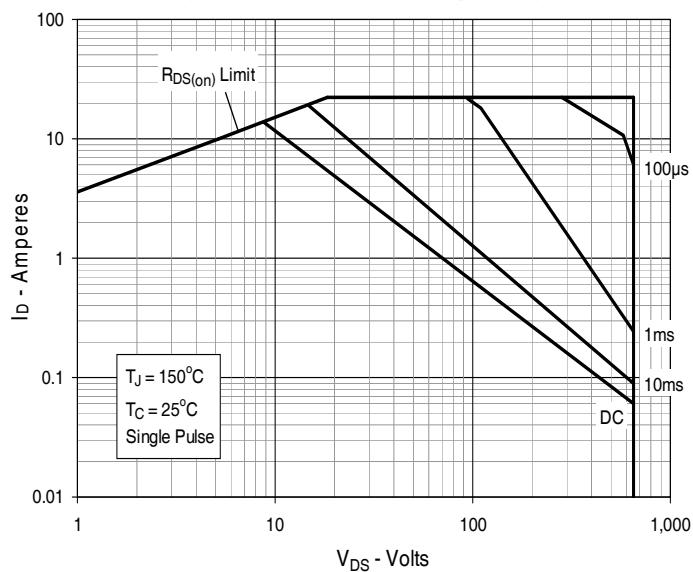
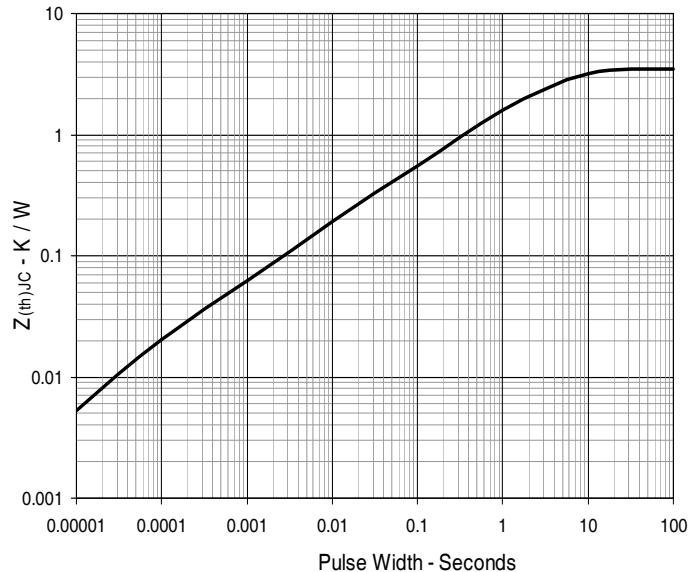
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**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** **Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** **Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$** **Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 10\text{A}$  Value vs. Junction Temperature****Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 10\text{A}$  Value vs. Drain Current****Fig. 6. Normalized Breakdown & Threshold Voltages vs. Junction Temperature**

**Fig. 7. Input Admittance****Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Output Capacitance Stored Energy**

**Fig. 13. Forward-Bias Safe Operating Area****Fig. 14. Maximum Transient Thermal Impedance**



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